	1					
PCN Number:	20190513000	PCN Da	ite:	٩ug.	. 27, 2019	
Title: Datasheet for DP83822HF, DP83822IF, DP83822H, DP83822I						
<b>Customer Contact:</b>	PCN Manager			De	pt: Quality Se	ervices
Change Type:					·	
Assembly Site		Design			Wafer Bump Site	
Assembly Process		Data Sheet			Wafer Bump Mat	erial
Assembly Material	s  F	art number chang	ge		Wafer Bump Prod	cess
Mechanical Specifi	cation	est Site			Wafer Fab Site	
Packing/Shipping/	Labeling 🔲 1	est Process			Wafer Fab Materi	ials
Wafer Fab Process						SS
Notification Details						
<b>Description of Chang</b>						
Texas Instruments Inco				y no	tification.	
The product datasheet			below.			
The following change h	istory provides fu	rther details.				
No. There are						
TEXAS INSTRUMENTS		DP	83822HF,	DP8	3822IF, DP83822H, D	P83822I
II OTTOMETTO			SNLS	S505E	-AUGUST 2016-REVISED MA	ARCH 2019
Changes from Pevision D	(March 2019) to Pevis	ion E				Page
Changes from Revision D	(March 2019) to Revis	ION E				Page
<ul> <li>Changed to fix typos on</li> </ul>	Table 1					8
Changes from Revision C	(April 2018) to Revision	on D				Page
Changed the description	for LED 1 in Din Euro	tions table				6
Changed the description for LED_1 in Pin Functions table						
Changed reset pin state for RX_D[3:0] pins in Table 1						
Added XO and XI capacitance						
Added Test Conditions to PMD OUTPUT section of the Electrical Characteristics Table  Changed Basemeter descriptions and units in Paget Timing Requirements table to match device performance.						
Changed Parameter descriptions and units in Reset Timing Requirements table to match device performance.      Changed NOTE for 4000ASE SX Signal Reset air polarity from Active LOW to Active LOW.						
Changed NOTE for 100BASE-FX Signal Detect pin polarity from Active LOW to Active HIGH.  Changed LED, 0 strep modes to remove Mode 2 and Mode 2.  Changed LED, 0 strep modes to remove Mode 2 and Mode 2.						
Changed LED_0 strap modes to remove Mode 2 and Mode 3.      Changed strap description for SD, FN air from Active LOW to Active LIGH.						
Changed strap description for SD_EN pin from Active LOW to Active HIGH.      Deleted LED 0 configuration table.						
Deleted LED_0 configuration table.  Changed LED_1 configuration table to marge LED_0 and LED_1 configuration into a single table for clarity.						
<ul> <li>Changed LED_1 Configuration table to merge LED_0 and LED_1 configuration into a single table for clarity.</li> <li>Changed note in LED Configuration section to clarify LED connections.</li> </ul>						
Added registers 0x0106, 0x0107, 0x01F, 0x0114, 0x0116, 0x0126, 0x04D4, 0x04D5, and 0x04D6						
Changed FUNCTION column of bits 3 and 2 in Table 37 to swap '0' and '1' functionality					64	
Changed SD_EN=0 to SD_EN=1 in Register 0x465 bit 0 Function						
Added 100Base-TX MII power consumption data for -40°C and 125°C						
Added Toobase-TX WIII p	ower consumption date	1101 -40 0 and 120 0				
The datasheet number	will be changing.					
Device Family		Change From:			Change To:	
, DD0202211E DD02022	VIE DD0202211				<u>-</u>	
DP83822HF, DP83822	21F, DP83822H,	SNLS505C			SNLS505E	
	DP83822I					
These changes may be reviewed at the datasheet links provided.						
http://www.ti.com/product/DP83822I						
Reason for Change:						
To reflect the device pin descriptions accurately.						
Anticipated impact o	·	•	r Reliah	ility	/ (positive / nea	ative):
No anticipated impact. This is a specification change announcement only. There are no changes						

to the actual device.							
Changes to product identification resulting from this PCN:							
None.							
Product Affected:							
DP83822HFRHBR	DP83822HFRHBT	DP83822HRHBR	DP83822HRHBT				
DP83822IFRHBR	DP83822IFRHBT	DP83822IRHBR	DP83822IRHBT				

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
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